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**TMS 2023**  
152<sup>nd</sup> Annual Meeting & Exhibition

MARCH 19–23, 2023  
SAN DIEGO CONVENTION CENTER &  
HILTON SAN DIEGO BAYFRONT  
SAN DIEGO, CALIFORNIA, USA  
#TMSANNUALMEETING



**SUBMIT AN ABSTRACT BY JULY 1 FOR THE FOLLOWING TMS2023 SYMPOSIUM:**

**ADDITIVE TECHNOLOGIES**

**Additive Manufacturing: Beyond the Beam IV**

Additive manufacturing comprises a breadth of processes, which have substantial commercial potential, design flexibility, and technical challenges. Significant corporate and government resources have been committed to energy beam powder bed fusion processes, while solid-state AM technologies have lagged in terms of overall funding for research and development. Furthermore, these “green part” additive technologies build extensively on decades of particulate material processes, which enable the additive manufacturing of non-weldable materials. These processes include, but are not limited to: binder jetting, material extrusion, material jetting, bound filament deposition, nano-inkjet printing, friction stir deposition, ordered powder lithography, and cold spray. Non-beam-based additive technologies face several unique challenges, such as: feedstock development, alloy design, depowdering, powder recycling, binder design, debinding, process modeling, microstructural development, dimensional accuracy, sintering distortion, and sintering support structure design.

This symposium will explore the relationships between the various aspects of process variables, properties, application performance, economics, and functionality of these non-beam additive techniques.

**ORGANIZERS**

**James Paramore** Army Research Laboratory  
**Daniel Lewis**, Texas A&M University  
**Kyle Tsaknopoulos**, Worcester Polytechnic Institute  
**Paul Prichard**, Kennametal Inc.

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